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# **HD74HC670**

4-by-4 Register File (with 3-state outputs)

REJ03D0639-0200 (Previous ADE-205-521) Rev.2.00 Mar 30, 2006

### **Description**

The HD74HC670, 16-bit register file is organized as 4 words of 4 bits each and separate on-chip decoding is provided for addressing the four word locations to either write-in or retrieve data.

This permits simultaneous writing into one location and reading from another word location. Four data inputs are available which are used to supply the 4-bit word to be stored. Location of the word is determined by the write-address inputs A and B in conjunction with a write-enable signal. Data applied at the inputs should be in its true form. That is, if a high-level signal is desired from the output, a high-level is applied at the data input for that particular bit location. The latch inputs are arranged so that new data will be accepted only if both internal address gate inputs are high. When this condition exists, data at the D input is transferred to the latch output. When the write-enable input,  $(G_W)$  is high, the data inputs are inhibited and their levels can cause no change in the information stored in the internal latches. When the read-enable input,  $(G_R)$  is high, the data outputs are inhibited and go into the high-impedance state. The individual address lines permit direct acquisition of data stored in any four of the latches. Four individual decoding gates are used to complete the address for reading a word. When the read address is made in conjunction with the read-enable signal, the word appears at the four outputs.

### **Features**

• High Speed Operation:  $t_{pd}$  (Read Select to Q) = 21 ns typ ( $C_L = 50$  pF)

High Output Current: Fanout of 15 LSTTL Loads

• Wide Operating Voltage:  $V_{CC} = 2 \text{ to } 6 \text{ V}$ 

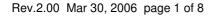
• Low Input Current: 1 ∞A max

• Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\propto$ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC670P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	_
HD74HC670FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.



### **Function Table**

	Write Inputs		Word					
W <sub>B</sub>	W <sub>A</sub>	G <sub>W</sub>	0	1	2	3		
L	L	L	Q = D	$Q_0$	$Q_0$	$Q_0$		
L	Н	L	$Q_0$	Q = D	$Q_0$	$Q_0$		
Н	L	L	$Q_0$	$Q_0$	Q = D	$Q_0$		
Н	Н	L	$Q_0$	$Q_0$	$Q_0$	Q = D		
X	X	Н	$Q_0$	$Q_0$	$Q_0$	$Q_0$		

	Read Inputs		Outputs					
R <sub>B</sub>	R <sub>A</sub>	G <sub>R</sub>	Q <sub>1</sub>	$\mathbf{Q}_2$	Q <sub>3</sub>	$\mathbf{Q}_4$		
L	L	L	W <sub>0</sub> B <sub>1</sub>	W <sub>0</sub> B <sub>2</sub>	W <sub>0</sub> B <sub>3</sub>	W <sub>0</sub> B <sub>4</sub>		
L	Н	L	W <sub>1</sub> B <sub>1</sub>	W <sub>1</sub> B <sub>2</sub>	W <sub>1</sub> B <sub>3</sub>	W <sub>1</sub> B <sub>4</sub>		
Н	L	L	W <sub>2</sub> B <sub>1</sub>	W <sub>2</sub> B <sub>2</sub>	W <sub>2</sub> B <sub>3</sub>	W <sub>2</sub> B <sub>4</sub>		
Н	Н	L	W <sub>3</sub> B <sub>1</sub>	W <sub>3</sub> B <sub>2</sub>	W <sub>3</sub> B <sub>3</sub>	W <sub>3</sub> B <sub>4</sub>		
X	Х	Н	Z	Z	Z	Z		

H : high level
L : low level
X : irrelevant

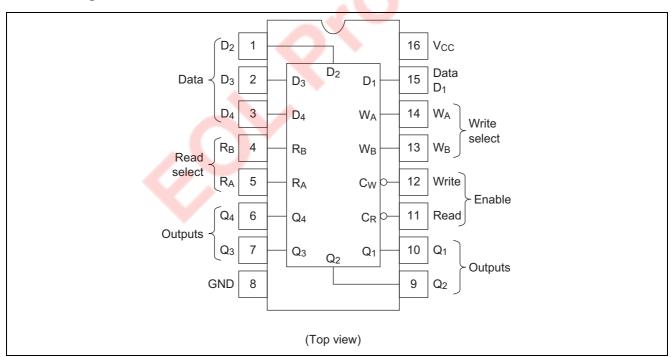
Z: high impedance (off)

(Q = D): The four selected internal flip-flop outputs will assume the states applied to the four external data inputs.

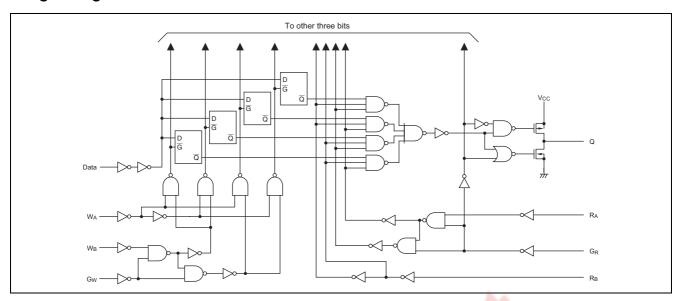
Q<sub>0</sub>: The level of Q before the indicated input conditions were estab<mark>lished.</mark>

 $W_0\,B_1\,\,$  : The first bit of word 0, etc.

## **Pin Arrangement**



## **Logic Diagram**



## **Absolute Maximum Ratings**

Item	Symbol	Ratings Page 1	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
Input / Output voltage	$V_{IN}, V_{OUT}$	−0.5 to V <sub>CC</sub> +0.5	V
Input / Output diode current	I <sub>IK</sub> , I <sub>OK</sub>	±20	mA
Output current	I <sub>OUT</sub>	±35	mA
V <sub>CC</sub> , GND current	I <sub>CC</sub> or I <sub>GND</sub>	±75	mA
Power dissipation	P <sub>T</sub>	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

## **Recommended Operating Conditions**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CC</sub>	2 to 6	V	
Input / Output voltage	V <sub>IN</sub> , V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	Ta	-40 to 85	°C	
		0 to 1000		$V_{CC} = 2.0 \text{ V}$
Input rise / fall time*1	t <sub>r</sub> , t <sub>f</sub>	0 to 500	ns	$V_{CC} = 4.5 \text{ V}$
		0 to 400		$V_{CC} = 6.0 \text{ V}$

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

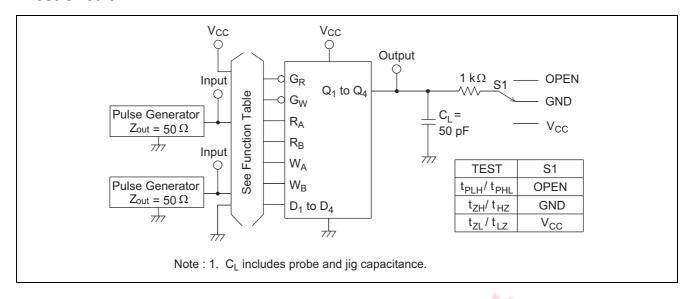
# **Electrical Characteristics**

			Т	a = 25°	С	Ta = -40 to+85°C				
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions	
Input voltage	V <sub>IH</sub>	2.0	1.5	_	_	1.5	_	٧		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_	_	4.2	_			
	V <sub>IL</sub>	2.0	_	_	0.5	_	0.5	٧		
		4.5	_	_	1.35	_	1.35			
		6.0	_	_	1.8	_	1.8			
Output voltage	V <sub>OH</sub>	2.0	1.9	2.0	_	1.9	_	٧	$Vin = V_{IH} \text{ or } V_{IL} \mid I_{OH} = -20  \text{$\sim$A}$	
		4.5	4.4	4.5	_	4.4	_			
		6.0	5.9	6.0	_	5.9	_			
		4.5	4.18	_	_	4.13	_		$I_{OH} = -6 \text{ mA}$	
		6.0	5.68	_	_	5.63	_		$I_{OH} = -7.8 \text{ mA}$	
	V <sub>OL</sub>	2.0		0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL} \mid_{OL} = 20  \triangle A$	
		4.5	_	0.0	0.1	_	0.1			
		6.0	_	0.0	0.1	_	0.1			
		4.5	_	_	0.26	_	0.33		$I_{OL} = 6 \text{ mA}$	
		6.0	_	_	0.26	_	0.33		$I_{OL} = 7.8 \text{ mA}$	
Off-state output	l <sub>OZ</sub>	6.0	_	_	±0.5	_	±5.0	∞A	$V_{\text{in}} = V_{\text{IN}} \text{ or } V_{\text{IL}},$	
current							4		Vout = V <sub>CC</sub> or GND	
Input current	lin	6.0	_	_	±0.1	_	±1.0	∞A	Vin = V <sub>CC</sub> or GND	
Quiescent supply current	I <sub>CC</sub>	6.0	_	_	4.0	_	40	∝A	Vin = $V_{CC}$ or GND, lout = $0 \propto A$	

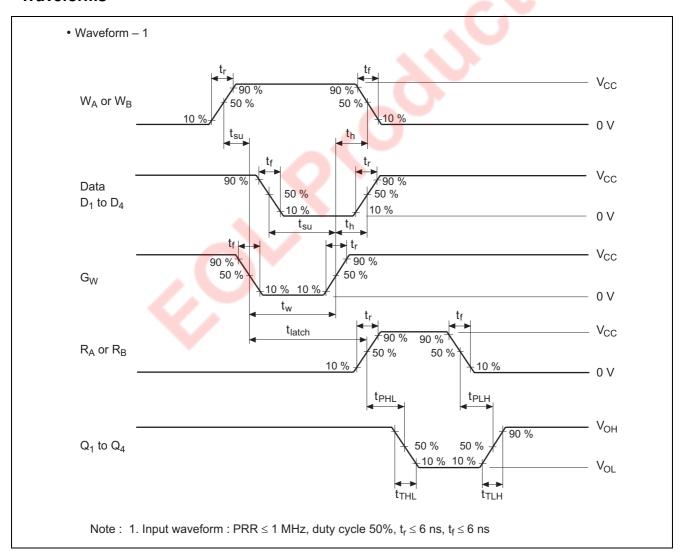
# Switching Characteristics ( $C_L = 50 \text{ pF}$ , Input $t_r = t_f = 6 \text{ ns}$ )

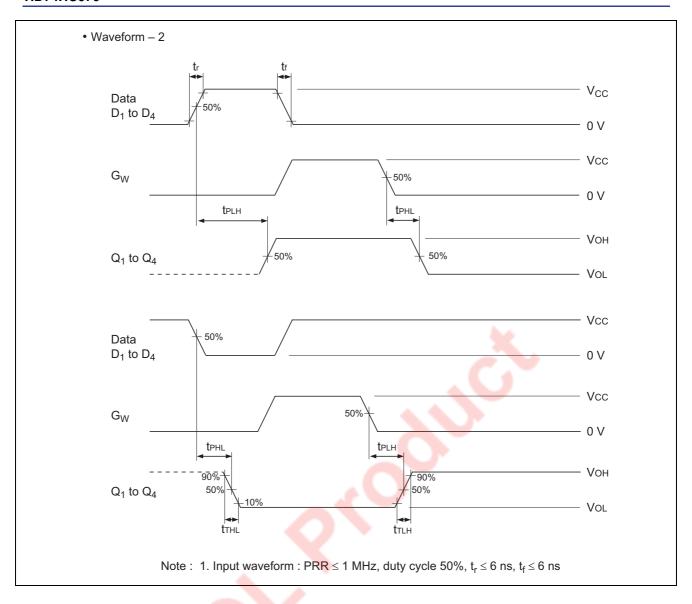
			Т	a = 25°	С	Ta = -40 to +85°C			
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Propagation delay	t <sub>PLH</sub>	2.0	_	_	160	_	200	ns	Read select to Q
time	t <sub>PHL</sub>	4.5	1	21	32	_	40		
		6.0	1	_	27	_	34		
	t <sub>PLH</sub>	2.0	_	_	200	_	250	ns	Write enable to Q
	t <sub>PHL</sub>	4.5	_	24	40	_	50		
		6.0	_	_	34	_	43		
	t <sub>PLH</sub>	2.0	_	_	150	_	190	ns	Data to Q
	t <sub>PHL</sub>	4.5	_	18	30	_	38		
		6.0	_	_	26	_	33		
Output enable	t <sub>zH</sub>	2.0	_	_	150	_	190	ns	
time	t <sub>ZL</sub>	4.5	_	18	30	_	38		
		6.0	_	_	26	_	33		
Output disable	t <sub>HZ</sub>	2.0	_	_	150	_	190	ns	
time	t <sub>LZ</sub>	4.5	_	17	30	_	38		
		6.0	_	_	26	_	33	3	
Pulse width	tw	2.0	80	_	_	100	_	ns	
		4.5	16	_	_	20	_		
		6.0	14	_	_	17	_ 4		
Setup time	t <sub>su</sub>	2.0	60	_	_	75	-	ns	Data to Write enable
		4.5	12	4	_	15	7	9.	
		6.0	10	_	_	13	-		
		2.0	60	_	_	75		ns	Write select to Write enable
		4.5	12	_	_	15	_		
		6.0	10	_	^\	13	_		
Hold time	t <sub>h</sub>	2.0	50	-		63	_	ns	Write enable to Data
		4.5	10	6	/_	13	_		
		6.0	9	_	_	11	_		
		2.0	50	_	_	63	_	ns	Write enable to Write select
		4.5	10		_	13	_		
		6.0	9		_	11	_		
Latch time for new	t <sub>latch</sub>	2.5	100	_	_	125	_	ns	
data		4.5	20	_	_	25	_		
		6.0	17	_	_	21	<b>—</b>		
Output rise/fall	t <sub>TLH</sub>	2.0	_	_	75	_	95	ns	
time	t <sub>THL</sub>	4.5	_	5	15	<u> </u>	19		
		6.0	_	_	13	_	16		
Input capacitance	Cin	_	_	5	10	_	10	pF	

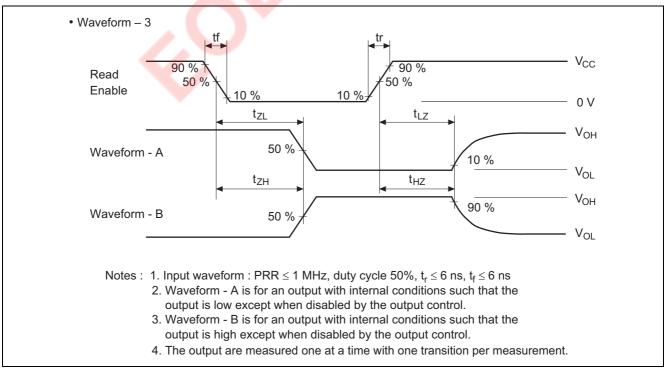
### **Test Circuit**



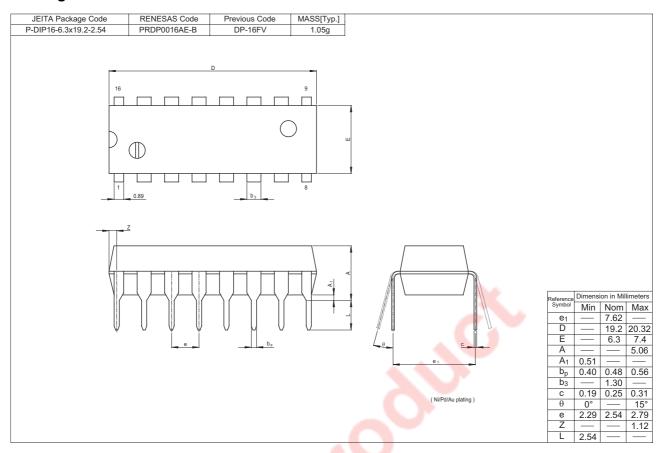
### **Waveforms**

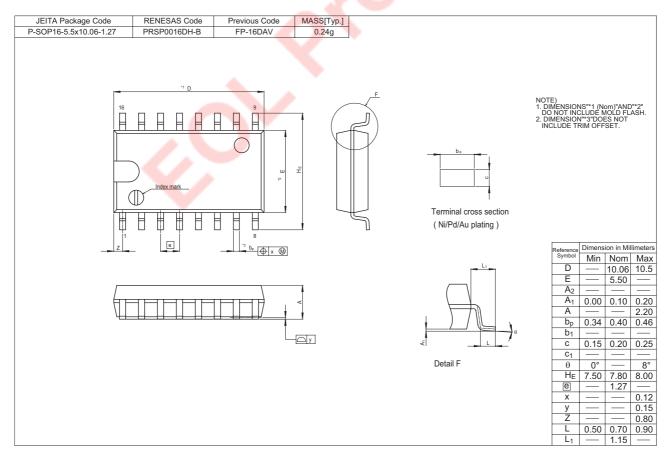






### **Package Dimensions**





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